

PROTECTION PRODUCTS
Absolute Maximum Rating

Rating	Symbol	Value	Units
Peak Pulse Power ($t_p = 8/20\mu s$)	P_{pk}	500	Watts
Peak Pulse Current ($t_p = 8/20\mu s$)	I_{pp}	15	A
Lead Soldering Temperature	T_L	260 (10 sec.)	°C
Operating Temperature	T_J	-55 to +125	°C
Storage Temperature	T_{STG}	-55 to +150	°C

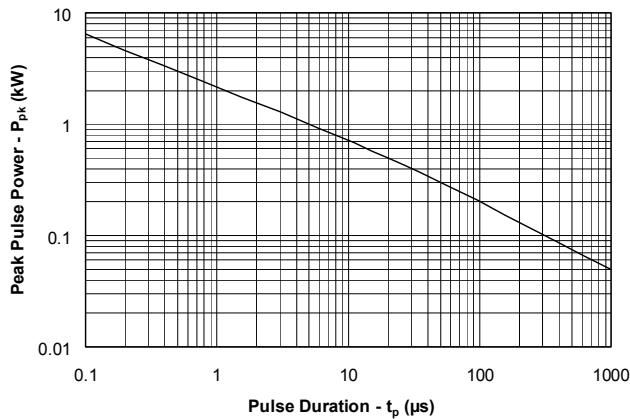
Electrical Characteristics

LCDA15C-6						
Parameter	Symbol	Conditions	Minimum	Typical	Maximum	Units
Reverse Stand-Off Voltage	V_{RWM}				15	V
Reverse Breakdown Voltage	V_{BR}	$I_t = 1mA$	16.7			V
Reverse Leakage Current	I_R	$V_{RWM} = 15V, T=25^\circ C$			5	μA
Clamping Voltage	V_C	$I_{pp} = 1A, t_p = 8/20\mu s$ Line-to-Ground			24	V
Clamping Voltage	V_C	$I_{pp} = 15A, t_p = 8/20\mu s$ Line-to-Ground			33	V
Junction Capacitance	C_J	Between I/O pins and Ground $V_R = 0V, f = 1MHz$		8	15	pF
		Between I/O pins $V_R = 0V, f = 1MHz$		3		pF

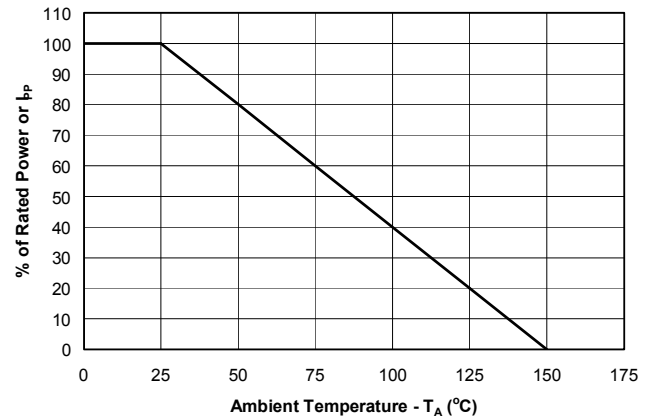
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Typical Characteristics

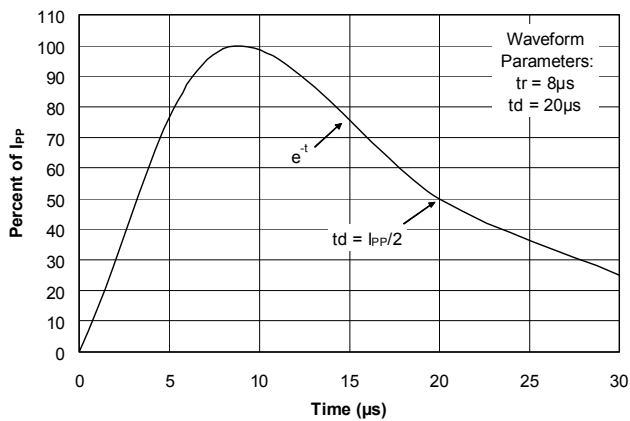
Non-Repetitive Peak Pulse Power vs. Pulse Time



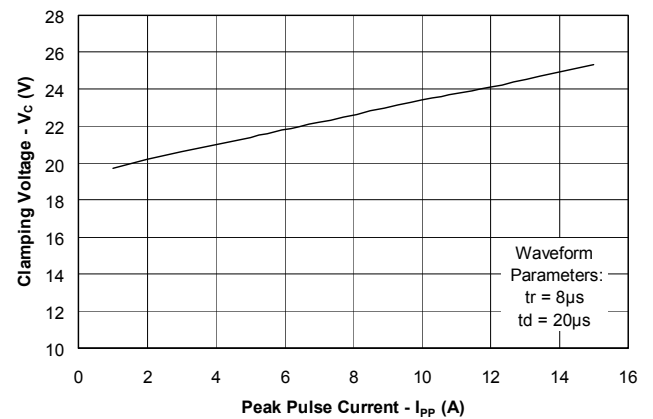
Power Derating Curve



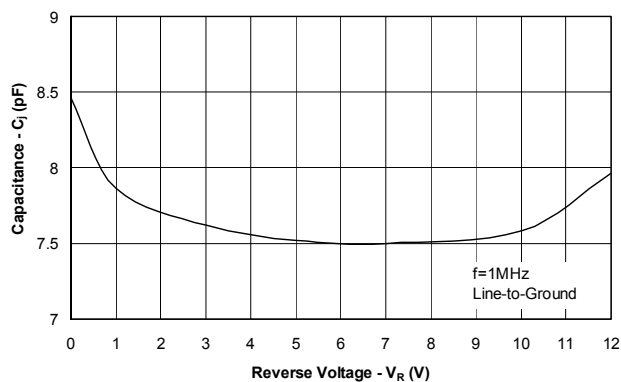
Pulse Waveform



Clamping Voltage vs. Peak Pulse Current



Capacitance vs. Reverse Voltage



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Applications Information

Device Connection Options for Protection of Six High-Speed Data Lines

The LCDA15C-6 may be configured to protect up to six I/O lines operating between 5 and 15V. It may be used to protect the most popular serial data interface standard lines making it ideal for use in equipment utilizing multi-mode transceivers. Data lines are connected at pins 1, 2, 3, 6, 7, and 8. Pins 4 and 5 are connected to ground. For best results, these pins should be connected directly to a ground plane on the board. The path length should be kept as short as possible to minimize parasitic inductance.

Multi-Mode Transceiver Protection

A typical multi-mode transceiver protection circuit is shown. The LCDA15C-6 is used to protect I/O lines with external connections. The LCDA15C-6 adds a maximum loading capacitance of 15pF with a working voltage of 15V. This allows the transceiver to safely operate in all modes without clipping or degradation of the signal.

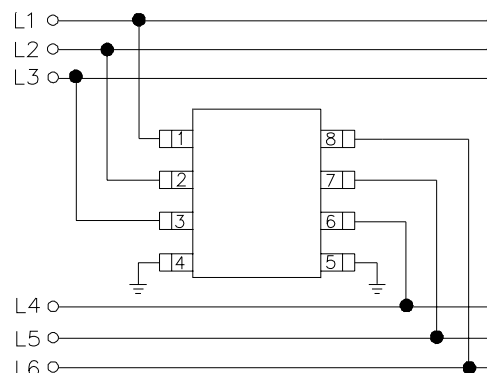
With proper design and layout, the transceiver port can be protected to >15kV (HBM per IEC 61000-4-2).

Circuit Board Layout Recommendations for Suppression of ESD.

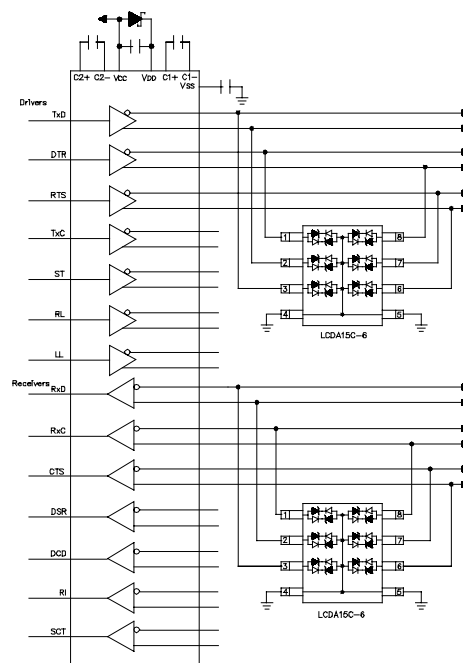
Good circuit board layout is critical for the suppression of fast rise-time transients such as ESD. The following guidelines are recommended:

- Place the LCDA15C-6 near the input terminals or connectors to restrict transient coupling.
- Minimize the path length between the LCDA15C-6 and the protected line.
- Minimize all conductive loops including power and ground loops.
- The ESD transient return path to ground should be kept as short as possible.
- Never run critical signals near board edges.
- Use ground planes whenever possible.

Device Connection

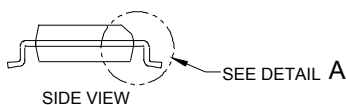
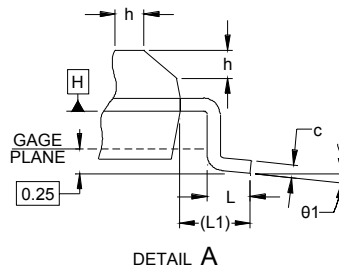
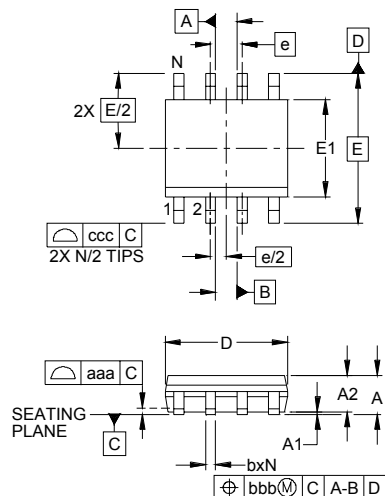


Multi-Mode Transceiver Protection Example



Matte Tin Lead Finish

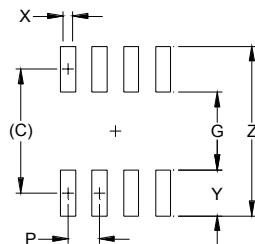
Matte tin has become the industry standard lead-free replacement for SnPb lead finishes. A matte tin finish is composed of 100% tin solder with large grains. Since the solder volume on the leads is small compared to the solder paste volume that is placed on the land pattern of the PCB, the reflow profile will be determined by the requirements of the solder paste. Therefore, these devices are compatible with both lead-free and SnPb assembly techniques. In addition, unlike other lead-free compositions, matte tin does not have any added alloys that can cause degradation of the solder joint.

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Outline Drawing - SO-8


DIM	INCHES			MILLIMETERS		
	MIN	NOM	MAX	MIN	NOM	MAX
A	.053	-	.069	1.35	-	1.75
A1	.004	-	.010	0.10	-	0.25
A2	.049	-	.065	1.25	-	1.65
b	.012	-	.020	0.31	-	0.51
c	.007	-	.010	0.17	-	0.25
D	.189	.193	.197	4.80	4.90	5.00
E1	.150	.154	.157	3.80	3.90	4.00
E	.236 BSC			6.00 BSC		
e	.050 BSC			1.27 BSC		
h	.010	-	.020	0.25	-	0.50
L	.016	.028	.041	0.40	0.72	1.04
L1	(.041)			(1.04)		
N	8			8		
θ1	0°	-	8°	0°	-	8°
aaa	.004			0.10		
bbb	.010			0.25		
ccc	.008			0.20		

NOTES:

1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).
2. DATUMS **-A-** AND **-B-** TO BE DETERMINED AT DATUM PLANE **-H-**
3. DIMENSIONS "E1" AND "D" DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.
4. REFERENCE JEDEC STD MS-012, VARIATION AA.

Land Pattern - SO-8


DIM	DIMENSIONS	
	INCHES	MILLIMETERS
C	(.205)	(5.20)
G	.118	3.00
P	.050	1.27
X	.024	0.60
Y	.087	2.20
Z	.291	7.40

NOTES:

1. THIS LAND PATTERN IS FOR REFERENCE PURPOSES ONLY. CONSULT YOUR MANUFACTURING GROUP TO ENSURE YOUR COMPANY'S MANUFACTURING GUIDELINES ARE MET.
2. REFERENCE IPC-SM-782A, RLP NO. 300A.

PROTECTION PRODUCTS**Ordering Information**

Part Number	Lead Finish	Qty per Reel	Reel Size
LCDA15C-6.TB	SnPb	500	7 Inch
LCDA15.C-6TBT	Pb Free	500	7 inch
LCDA15C-6	SnPb	95/Tube	N/A
LCDA15C-6.T	Pb Free	95/Tube	N/A

Note: Lead-free devices are RoHS/WEEE Compliant

Contact Information

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